

February 2015

FSA2567 — Low-Power, Dual SIM Card Analog Switch

Features

- Low On Capacitance for Data Path: 10 pF Typical
- Low On Resistance for Data Path: 6 Ω Typical
- Low On Resistance for Supply Path: 0.4 Ω Typical
- Wide V_{CC} Operating Range: 1.65 V to 4.3 V
- Low Power Consumption: 1 µA Maximum
 - 15 μA Maximum I_{CCT} Over Expanded Voltage Range (V_{IN}=1.8 V, V_{CC}=4.3 V)
- Wide -3 db Bandwidth: > 160 MHz
- Packaged in:
 - Pb-free 16-Lead MLP & 16-Lead UMLP
- 3 kV ESD Rating, >12 kV Power/GND ESD Rating

Applications

- Cell phone, PDA, Digital Camera, and Notebook
- LCD Monitor, TV, and Set-Top Box

Description

The FSA2567 is a bi-directional, low-power, dual double-pole, double-throw (4PDT) analog switch targeted at dual SIM card multiplexing. It is optimized for switching the WLAN-SIM data and control signals and dedicates one channel as a supply-source switch.

The FSA2567 is compatible with the requirements of SIM cards and features a low on capacitance (C_{ON}) of 10 pF to ensure high-speed data transfer. The V_{SIM} switch path has a low R_{ON} characteristic to ensure minimal voltage drop in the dual SIM card supply paths.

The FSA2567 contains special circuitry that minimizes current consumption when the control voltage applied to the SEL pin is lower than the supply voltage (V_{CC}). This feature is especially valuable in ultra-portable applications, such as cell phones; allowing direct interface with the general-purpose I/Os of the baseband processor. Other applications include switching and connector sharing in portable cell phones, PDAs, digital cameras, printers, and notebook computers.

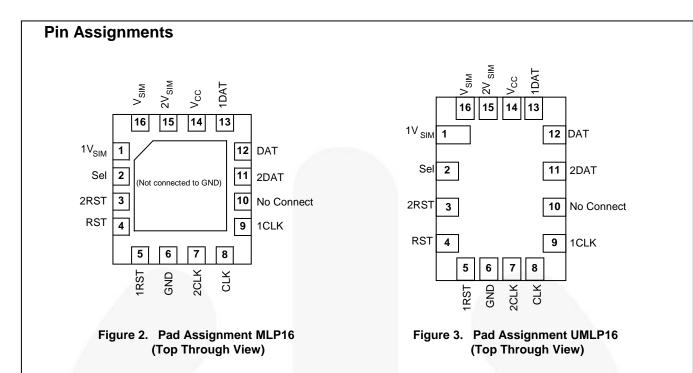
Ordering Information

Part Number	Top Mark	Operating Temperature Range	Package
FSA2567MPX	FSA2567	-40 to +85°C	16-Lead, Molded Leadless Package (MLP) Quad, JEDEC MO-220, 3 mm Square
FSA2567UMX	GX		16-Lead, Quad, Ultrathin Molded Leadless Package (UMLP), 1.8 x 2.6 mm

W For Fairchild's definition of Eco Status, please visit: <u>http://www.fairchildsemi.com/company/green/rohs_green.html</u>.

1V_{SIM} 2V_{SIM} 1RST 2RST 1CLK 2CLK 1DAT 2DAT 2DAT





Pin Definitions

Pin	Description
nDAT, nRST, nCLK	Multiplexed Data Source Inputs
nV _{SIM}	Multiplexed SIM Supply Inputs
V _{SIM} , DAT, RST, CLK	Common SIM Ports
Sel	Switch Select

Truth Table

Sel Function	
Logic LOW	1DAT = DAT, 1RST = RST, 1CLK = CLK, $1V_{SIM} = V_{SIM}$
Logic HIGH	$2DAT = DAT$, $2RST = RST$, $2CLK = CLK$, $2V_{SIM} = V_{SIM}$

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Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Unit
V _{CC}	Supply Voltage		-0.5	+5.5	V
VCNTRL	DC Input Voltage (Sel) ⁽¹⁾		-0.5	Vcc	V
V _{SW}	DC Switch I/O Voltage ⁽¹⁾		-0.5	V _{CC} + 0.3	V
I _{IK}	DC Input Diode Current		-50		mA
I _{SIM}	DC Output Current - V _{SIM}			350	mA
I _{OUT}	DC Output Current – DAT, CLK, RST			35	mA
T _{STG}	Storage Temperature		-65	+150	°C
		All Pins	6	3	
ESD	Human Body Model, JEDEC: JESD22-A114	I/O to GND		12	kV
	Charged Device Model, JEDEC: JESD22-C101			2	

Note:

1. The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
V _{CC}	Supply Voltage	1.65	4.30	V
V _{CNTRL}	Control Input Voltage (Sel) ⁽²⁾	0	V _{cc}	V
Vsw	Switch I/O Voltage	-0.5	Vcc	V
I _{SIM}	DC Output Current - V _{SIM}		150	mA
lout	DC Output Current – DAT, CLK, RST		25	mA
T _A	Operating Temperature	-40	+85	°C

Note:

2. The control input must be held HIGH or LOW; it must not float.

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DC Electrical Characteristics

All typical values are at 25°C, 3.3 V V_{CC} unless otherwise specified.

O week al	Denemeter	O an dition a	V 00	T _A =- 40°C to +85°C		+85⁰C	11
Symbol	Parameter	Conditions	V _{cc} (V)	Min.	Тур.	Max.	Units
VIK	Clamp Diode Voltage	I _{IN} = -18 mA	2.7			-1.2	V
			1.65 to 2.3	1.1			
V_{IH}	Input Voltage High		2.7 to 3.6	1.3			V
			4.3	1.7			
			1.65 to 2.3			0.4	
VIL	Input Voltage Low		2.7 to 3.6			0.5	V
			4.3			0.7	
l _{in}	Control Input Leakage	$V_{SW} = 0$ to V_{CC}	4.3	-1		1	μA
I _{nc(off),} I _{no(off),}	Off State Leakage	nRST, nDAT, nCLK, nV _{SIM} = 0.3 V or 3.6 V Figure 10	4.3	-60		60	nA
Baura	Data Path Switch On Resistance ⁽³⁾	V _{SW} = 0, 1.8 V, I _{ON} = -20 mA Figure 9	1.8		7.0	12.0	
R _{OND}		V _{SW} = 0, 2.3 V, I _{ON} = -20 mA Figure 9	2.7		6.0	10.0	Ω
P	V _{SIM} Switch	V _{sw} = 0, 1.8V, I _{ON} = -100mA Figure 9	1.8		0.5	0.7	
R _{ONV}	On Resistance ⁽³⁾	V_{SW} = 0, 2.3 V, I_{ON} = -100 mA Figure 9	2.7		0.4	0.6	Ω
ΔR_{OND}	Data Path Delta On Resistance ⁽⁴⁾	V _{SW} = 0 V, I _{ON} = -20 mA	2.7		0.2		Ω
Icc	Quiescent Supply Current	$V_{CNTRL} = 0$ or V_{CC} , $I_{OUT} = 0$	4.3			1.0	μA
	Increase in Icc	$V_{CNTRL} = 2.6 V, V_{CC} = 4.3 V$	4.3		5.0	10.0	μA
ICCT	Current Per Control Voltage and V _{CC}	$V_{CNTRL} = 1.8 V, V_{CC} = 4.3 V$	4.3		7.0	15.0	μA

Notes:

3. Measured by the voltage drop between nDAT, nRST, nCLK and relative common port pins at the indicated current through the switch. On resistance is determined by the lower of the voltage on the relative ports.

4. Guaranteed by characterization.

AC Electrical Characteristics

All typical value are for V_CC=3.3V at 25°C unless otherwise specified.

0	Parameter	O omalition o	N 00	T _A =- 40°C to +85°C			
Symbol	Parameter	Conditions	V _{cc} (V)	Min.	Тур.	Max.	Units
t _{ond}	Turn-On Time Sel to Output	R _L = 50 Ω, C _L = 35 pF V _{SW} = 1.5 V	1.8 ⁽⁵⁾		65	95	ns
CIND	(DAT,CLK,RST)	Figure 11, Figure 12	2.7 to 3.6		42	60	ns
t _{OFFD}	Turn-Off Time Sel to Output	R _L = 50 Ω, C _L = 35 pF V _{SW} = 1.5 V	1.8 ⁽⁵⁾		30	50	ns
GITD	(DAT,CLK,RST)		2.7 to 3.6		20	40	ns
t _{onv}	Turn-On Time	$R_L = 50 \Omega$, $C_L = 35 pF$ $V_{SW} = 1.5 V$ Figure 11, Figure 12	1.8 ⁽⁵⁾		55	80	ns
UNV		Figure 11, Figure 12	2.7 to 3.6		35	55	ns
t _{OFFV}	Turn-Off Time	1/200 - 1.5	1.8 ⁽⁵⁾		35	50	
OFFV	Sel to Output (V _{SIM})		2.7 to 3.6		22	40	ns
t _{PD}	Propagation Delay ⁽⁵⁾ (DAT,CLK,RST)	C_L = 35 pF, R_L = 50 Ω Figure 11, Figure 13	3.3		0.25		ns
t _{BBMD}	Break-Before-Make ⁽⁵⁾ (DAT,CLK,RST)	$R_L = 50 \Omega$, $C_L = 35 pF$ $V_{SW1} = V_{SW2} = 1.5 V$ Figure 15	2.7 to 3.6	3	18		ns
t _{BBMV}	Break-Before-Make ⁽⁵⁾ (V_{SIM})	$R_L = 50 \Omega$, $C_L = 35 pF$ $V_{SW1} = V_{SW2} = 1.5 V$ Figure 15	2.7 to 3.6	3	12		ns
Q	Charge Injection (DAT,CLK,RST)	$\begin{array}{l} C_{\text{L}} = 50 \text{ pF}, \text{R}_{\text{GEN}} = 0 \ \Omega, \\ V_{\text{GEN}} = 0 \ V \end{array}$	2.7 to 3.6		10		pC
O _{IRR}	Off Isolation (DAT,CLK,RST)	$R_L = 50 \Omega$, f = 10 MHz Figure 17	2.7 to 3.6		-60		dB
Xtalk	Non-Adjacent Channel Crosstalk (DAT,CLK,RST)	$R_L = 50 \Omega$, f = 10 MHz Figure 18	2.7 to 3.6		-60		dB
BW	-3 db Bandwidth (DAT,CLK,RST)	$R_L = 50 \Omega$, $C_L = 5 pF$ Figure 16	2.7 to 3.6		475		MHz

Note:

5. Guaranteed by characterization.

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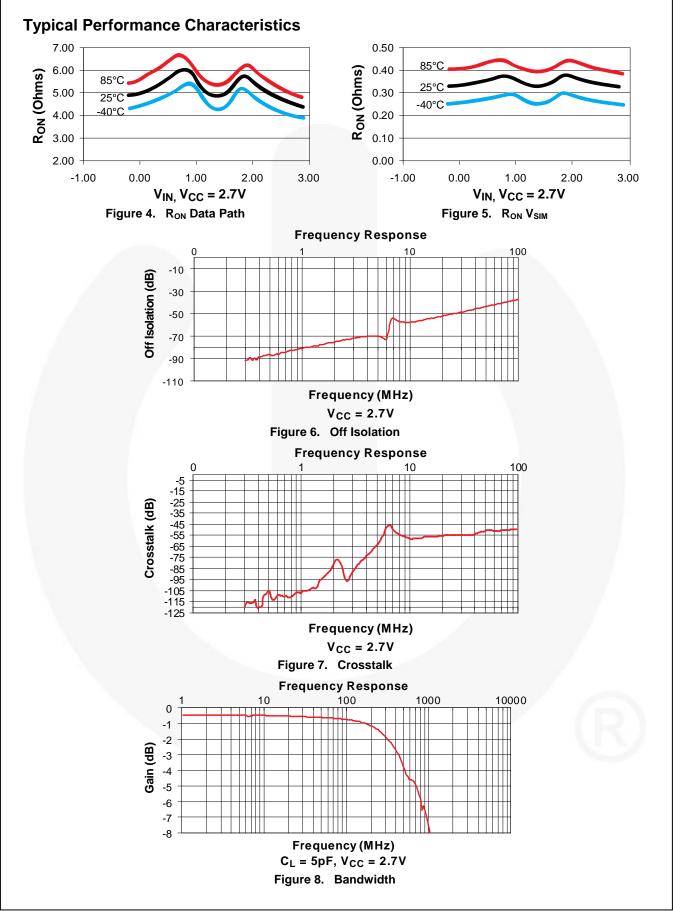
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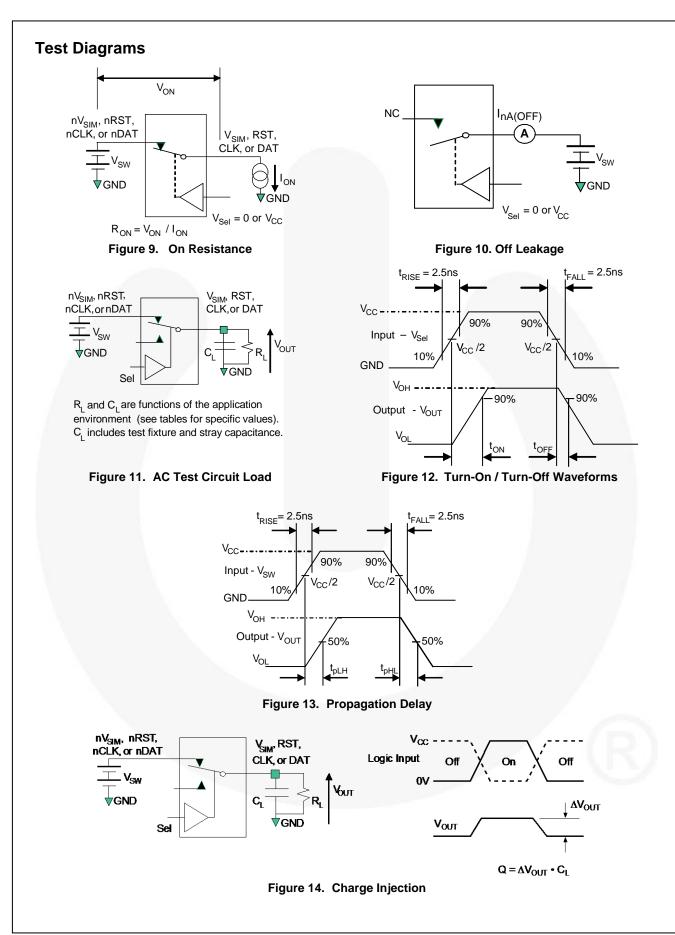
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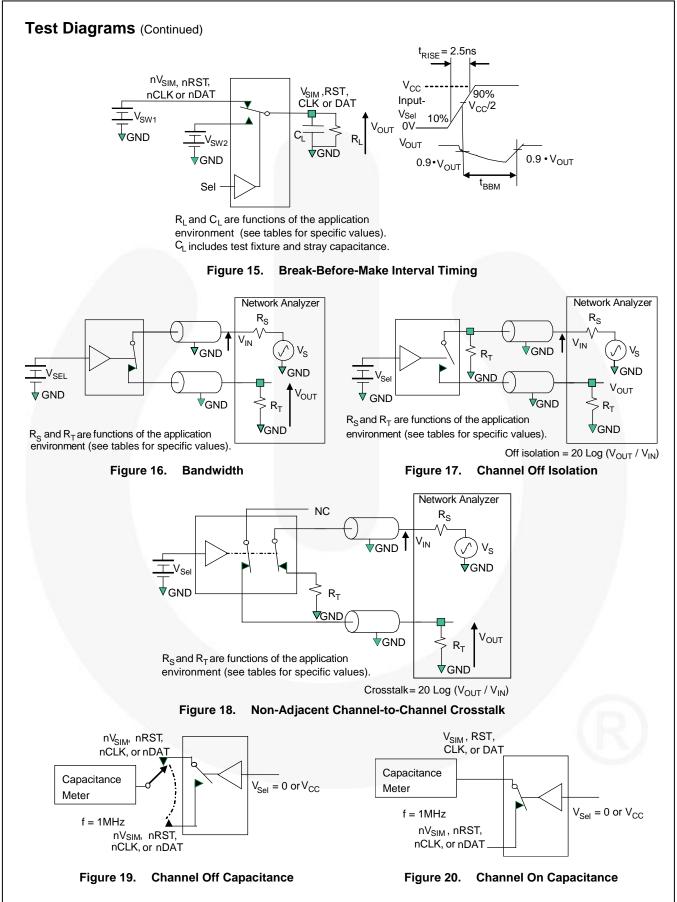
Cumhal	Deveneter		T _A =-	T _A =- 40°C to +85°C		
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
C _{IN}	Control Pin Input Capacitance	$V_{CC} = 0 V$		1.5		
C _{OND}	RST, CLK, DAT On Capacitance ⁽⁶⁾	V _{CC} = 3.3 V, f = 1 MHz Figure 20		10	12	
C _{ONV}	V _{SIM} On Capacitance ⁽⁶⁾	V _{CC} = 3.3 V, f = 1 MHz Figure 20		110	150	pF
COFFD	RST, CLK, DAT Off Capacitance	V _{CC} = 3.3 V, Figure 19		3		
C_{OFFV}	V _{SIM} Off Capacitance	V _{CC} = 3.3 V, Figure 19		40		

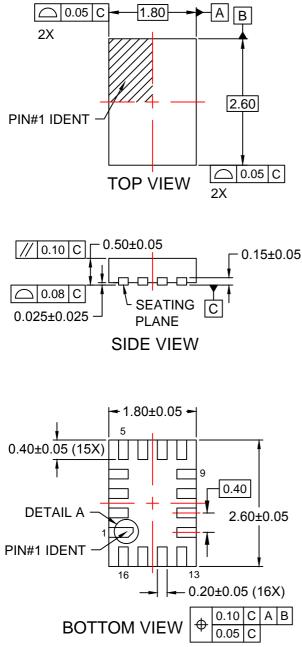
Note:

6. Guaranteed by characterization.



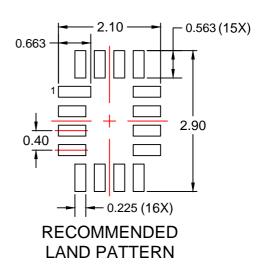


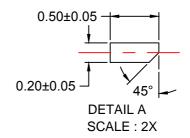


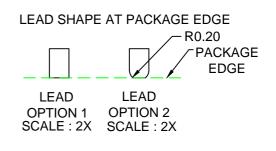


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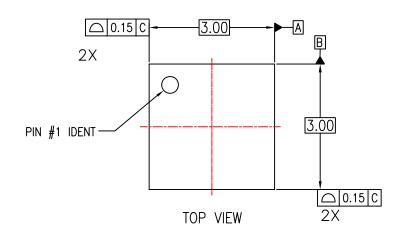


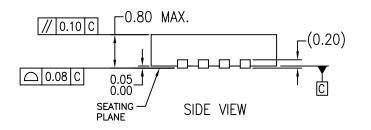


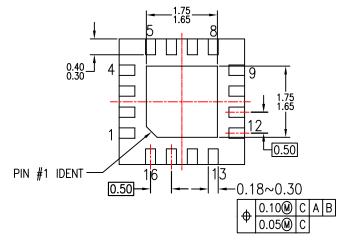


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	REVISIONS							
LTR	DESCRIPTION	EDCN	DATE	BY/APP'D				
А	RELEASE TO DOCUMENT CONTROL	ECN-MKT-MLP16B	21-2-05	FEITAN				
В	Lead length Changed from 0.35–0.45 to 0.30–0.40	ECN-MKT-MLP16B revB	10-6-05	Jkingsbury				





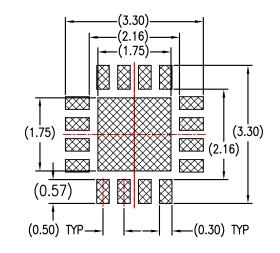


BOTTOM VIEW

NOTES:

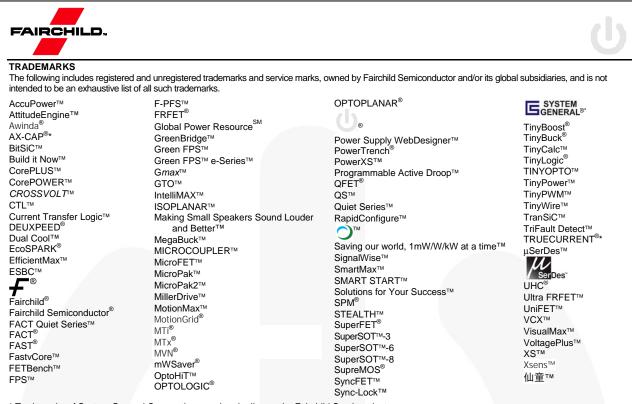
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